

Features

- Low on-resistance
- Low input capacitance
- Fast switching speed
- ESD protection up to 1.5kV (Human body mode)

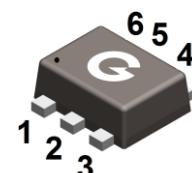
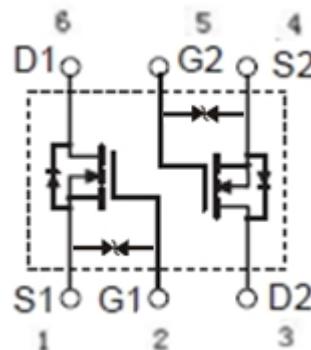
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Typical Applications

- DC-DC converters
- Power management functions
- Battery operated systems and solid-state relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

Mechanical Data

- Case: SOT-563
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin-Plated Leads, Solderability-per MIL-STD-202, Method 208



SOT-563

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
BSS138LV	SOT-563	3000 pcs / Tape & Reel	MM5.

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	50	V
Gate-to-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current ($V_{GS} = 4.5\text{V}$) *1	I_D	210	mA

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation *1	P_D	0.25	W
Thermal Resistance Junction-to-Air *1	$R_{\theta JA}$	248	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Lead *1	$R_{\theta JL}$	143	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Case *1	$R_{\theta JC}$	159	$^\circ\text{C/W}$
Operating Junction Temperature Range	T_J	-55 to +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
V_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$	50	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 50\text{V}$, $V_{GS} = 0\text{V}$	-	-	1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$	-	-	± 10	μA
On Characteristics ^{*2}						
$R_{DS(ON)}$	Static Drain-Source On-resistance	$V_{GS} = 10\text{V}$, $I_D = 0.5\text{A}$	-	1.55	2.5	Ω
		$V_{GS} = 4.5\text{V}$, $I_D = 0.2\text{A}$	-	1.82	3	
		$V_{GS} = 2.5\text{V}$, $I_D = 0.1\text{A}$	-	4.36	5.5	
$V_{GS(\text{TH})}$	Static Drain-Source On-resistance	$V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$	0.8	1.0	1.5	V
Dynamic Characteristics ^{*3}						
C_{iss}	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1.0\text{MHz}$	-	43	-	pF
C_{oss}	Output Capacitance		-	14	-	
C_{rss}	Reverse Transfer Capacitance		-	8	-	
Switching Characteristics ^{*3}						
Q_G	Total Gate-Charge	$V_{DD} = 25\text{V}$ $V_{GS} = 4.5\text{V}$ $I_D = 0.2\text{A}$	-	1.9	-	nC
Q_{GS}	Gate to Source Charge		-	0.9	-	
Q_{GD}	Gate to Drain (Miller) Charge		-	0.3	-	
$t_{d(on)}$	Turn-on Delay Time	$V_{DD} = 30\text{V}$, $I_D = 0.2\text{A}$ $V_{GS} = 10\text{V}$, $R_G = 25\Omega$	-	2.7	-	ns
t_r	Turn-on Rise Time		-	2.5	-	
$t_{d(off)}$	Turn-Off Delay Time		-	19	-	
t_f	Turn-Off Fall Time		-	11	-	
Source-Drain Diode Characteristics						
V_{SD}	Diode Forward Voltage ^{*2}	$I_S = 0.5\text{A}$, $V_{GS} = 0\text{V}$	-	0.93	1.4	V
t_{rr}	Reverse Recovery Time	$I_{SD} = 1\text{A}$, $V_{GS} = 0\text{V}$ $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	21.1	-	ns
Q_{rr}	Reverse Recovery Charge		-	9.48	-	nC

Notes:

- 1、 The data tested by surface mounted on a 23mm * 18mm * 1mm FR4-epoxy P.C.B
- 2、 Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
- 3、 Guaranteed by design, not subject to production.

Ratings and Characteristic Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

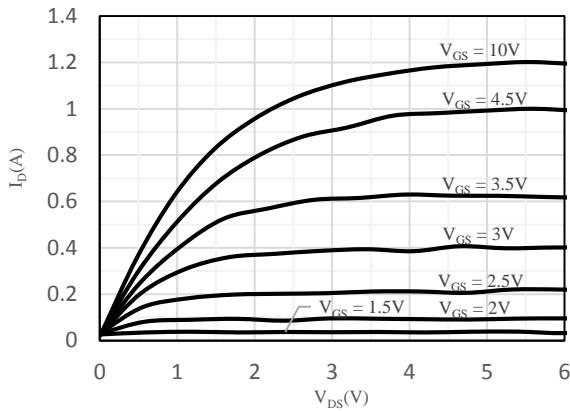


Fig 1 Output Characteristics

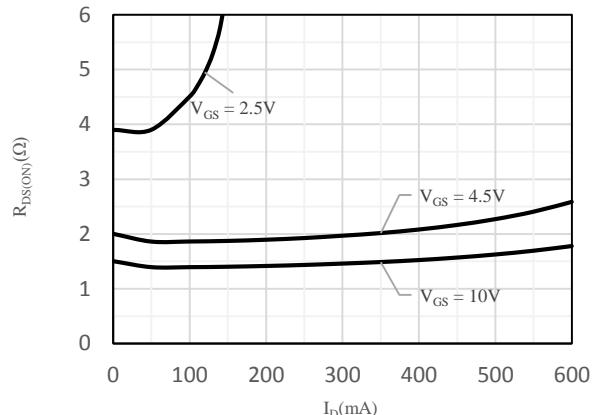


Fig 2 On-Resistance vs. Drain Current
and Gate Voltage

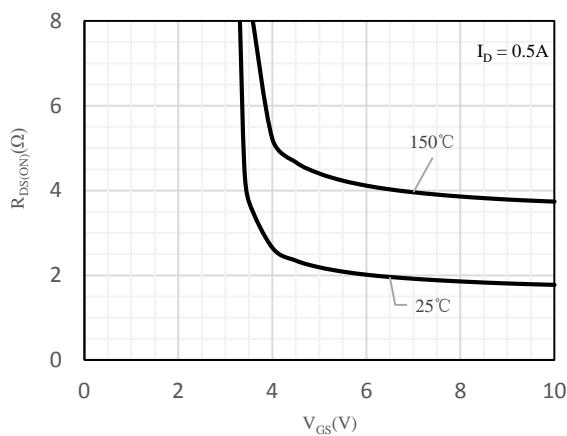


Fig 3 On-Resistance vs. Gate-Source Voltage

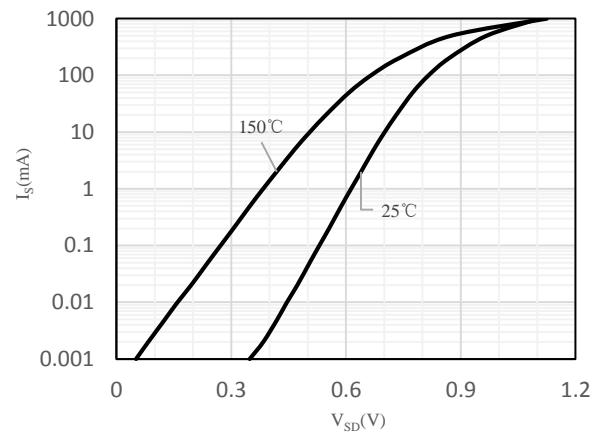


Fig 4 Body-Diode Characteristics

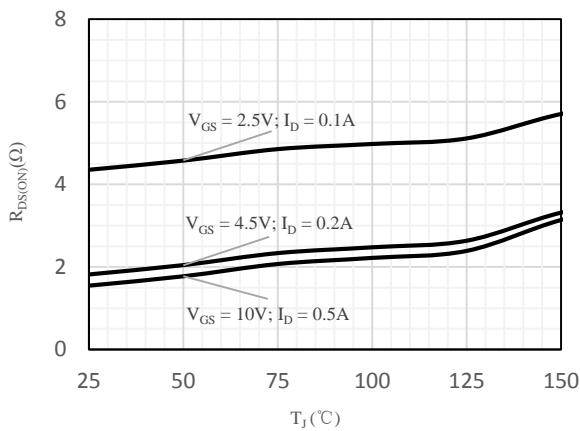


Fig 5 On-Resistance vs. Junction Temperature

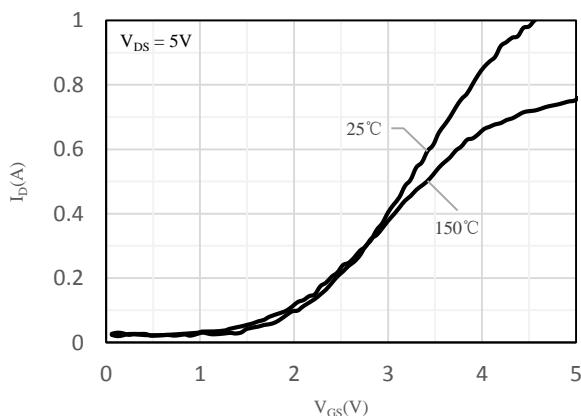


Fig 6 Transfer Characteristics

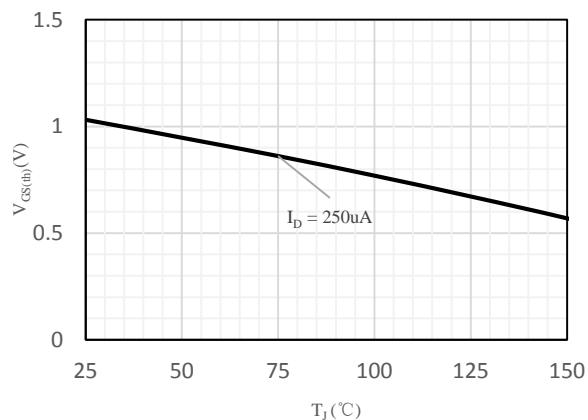


Fig 7 Gate Voltage vs. Junction Temperature

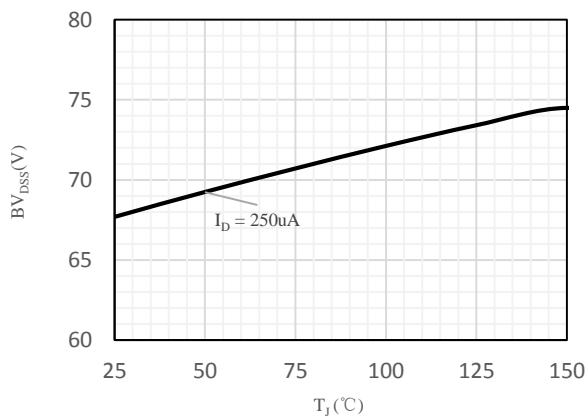


Fig 8 Drain-Source vs. Junction Temperature

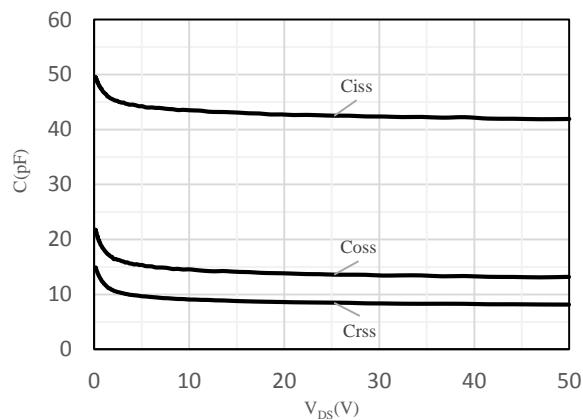


Fig 9 Capacitance Characteristics

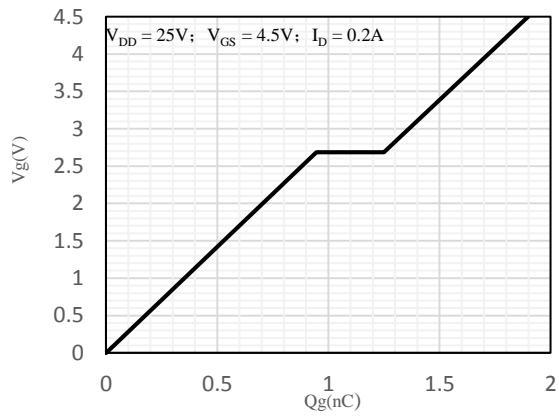
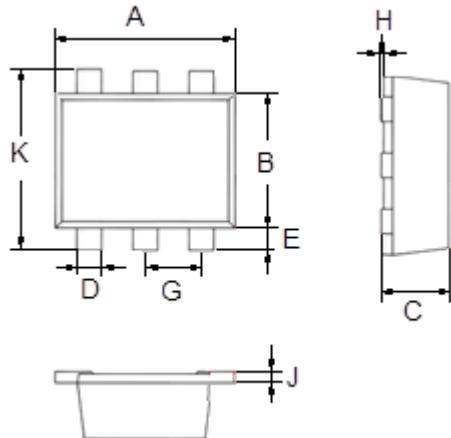
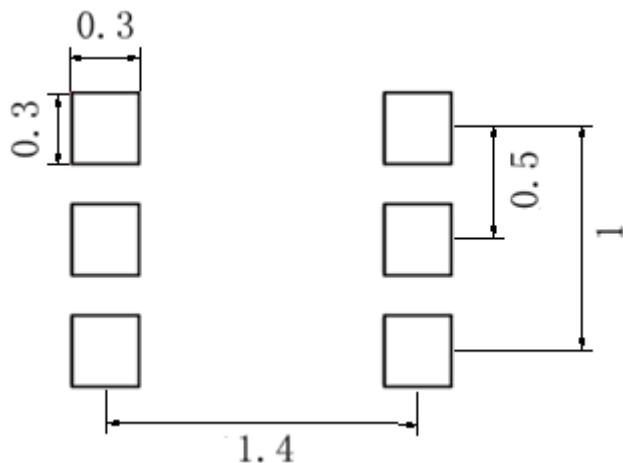


Fig 10 Gate-Charge Characteristics

Package Outline Dimensions (Unit: mm)


SOT-563		
Dimension	Min.	Max.
A	1.500	1.700
B	1.100	1.300
C	0.525	0.600
D	0.170	0.270
E	0.100	0.300
G	0.450	0.550
H	0.000	0.050
J	0.090	0.160
K	1.500	1.700

Mounting Pad Layout (Unit: mm)

SOT-563

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